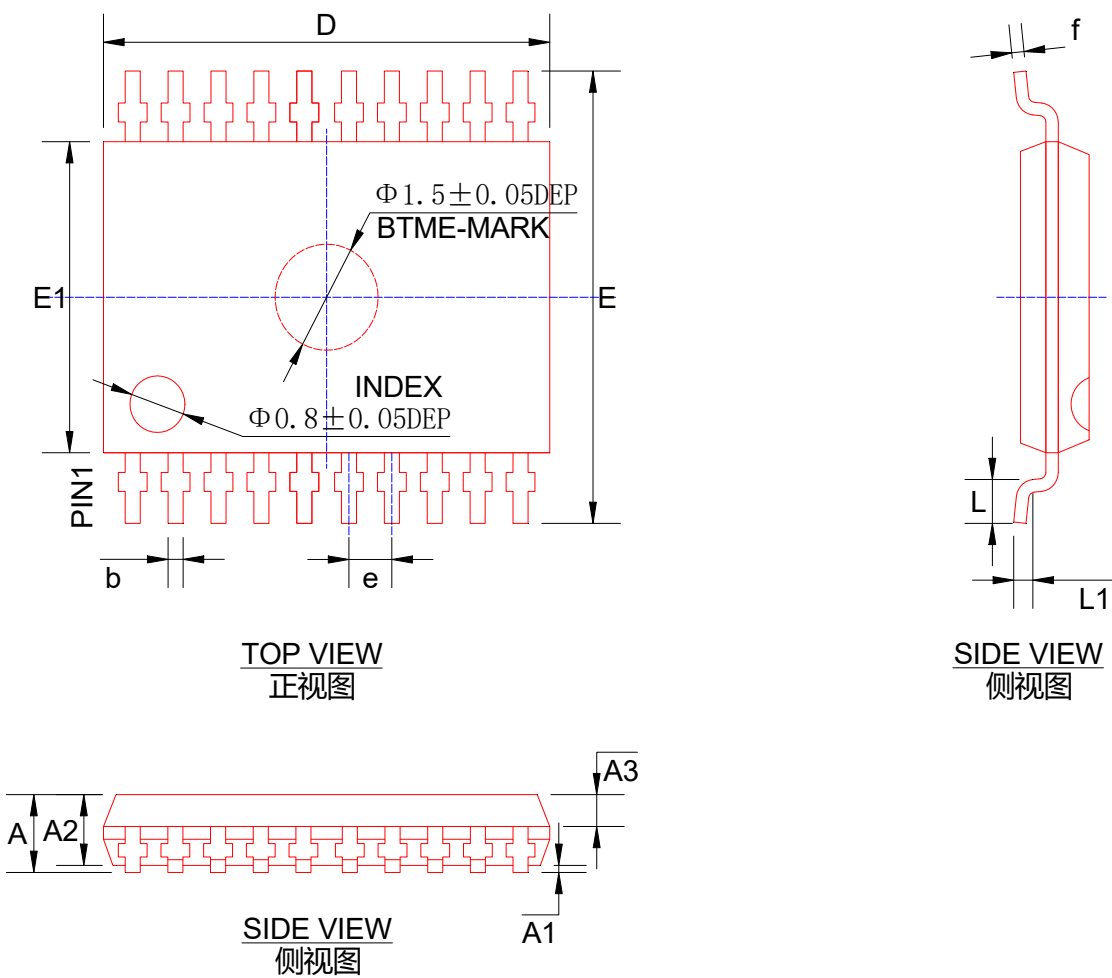


	深圳市锐骏半导体有限公司 ShenZhen Ruichips Semiconductor CO.,LTD	编号	RU-001-TSSOP20-A-001
	封装外形尺寸（POD）规范	版本	A/1
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TSSOP20



- NOTE:
- 1: ALL UNITS ARE IN MILLIMETER.
 - 2: EJECTOR PIN MARK POSITION MAY VARY FROM DIFFERENT MOLD.
 - 3: ALL DIMENSIONS REFER TO JEDEC.DO NOT INCLUDE MOLD FLASH OR PROTRUSIONS.

SYMBOL	MM			INCH		
	MIN	NOM	MAX	MIN	NOM	MAX
A	—	—	1.200	—	—	0.047
A1	0.050	0.100	0.150	0.002	0.004	0.006
A2	0.950	1.000	1.050	0.037	0.039	0.041
A3	0.411	0.436	0.461	0.016	0.017	0.018
b	0.195	0.220	0.245	0.008	0.009	0.010
e	0.620	0.650	0.680	0.024	0.026	0.027
D	6.400	6.500	6.600	0.252	0.256	0.260
E	6.300	6.400	6.500	0.248	0.252	0.256
E1	4.300	4.400	4.500	0.169	0.173	0.177
f	0.130	—	0.180	0.005	—	0.007
L	0.550	0.600	0.650	0.022	0.024	0.026
L1	0.25BSC			0.010BSC		